

# **Notice for TAIYO YUDEN Products**

Please read this notice before using the TAIYO YUDEN products.

#### ? REMINDERS

#### Product Information in this Catalog

Product information in this catalog is as of March 2023. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

#### Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

#### Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

#### Limited Application

#### 1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN.

TAIYO YUDEN has the product series intended for use in the following equipment. Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

Application	Product Series		Quality Grade*3
Application	Equipment *1	Category (Part Number Code *2)	Quality Grade 9
Automotive	Automotive Electronic Equipment (POWERTRAIN, SAFETY)	А	1
Adiomotive	Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT)	С	2
Industrial	Telecommunications Infrastructure and Industrial Equipment	В	2
Medical	Medical Devices classified as GHTF Class C (Japan Class III)	M	2
	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	L	3
Consumer	General Electronic Equipment	S	3
Consumer	Only for Mobile Devices *4	E	4

<sup>\*</sup>Notes:1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAIYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAIYO YUDEN before using our products for equipment other than those covered by the product series.

<sup>2.</sup> On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details, please check the explanatory materials regarding the part numbering system of each of our products.

<sup>3.</sup> Each product series is assigned a "Quality Grade" from 1 to 4 in order of higher quality. Please do not incorporate a product into any equipment with a higher Quality Grade than the Quality Grade of such product without the prior written consent of TAIYO YUDEN.

<sup>4.</sup> The applications covered by this product series are limited to mobile devices (smartphone, tablet PC, smartwatch, handheld game console, etc.) among general electronic equipment for consumer. The design, specifications and operating environment, etc. differ from those of the product series for "General Electronic Equipment" (Category: S), so please check the individual product specification sheets for details. The product series for "General Electronic Equipment" (Category: S) can also be used for mobile devices.

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

#### 2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

#### 3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment \*1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices \*2
- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above
- \*Notes:1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
  - 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

#### 4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

#### Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

#### Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

#### Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets.

#### ■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

#### Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

2023

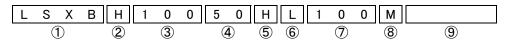
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# Wire-wound Ferrite Power Inductors LSXBH10050 for General Electronic Equipment for Consumer

REFLOW

#### ■PART NUMBER

\*Operating Temp.:-25~+105°C (Including self-generated heat)



#### (1)Series

<u> </u>	
Code	
(1)(2)(3)(4)	
LSXB	Wire-wound Ferrite Power Inductor for General Electronic Equipment for Consumer

#### (1) Product Group

Code	
L	Inductors

#### (2) Category

Code	Recommended equipment	Quality Grade
S	General Electronic Equipment for Consumer	3

#### (3) Type

Code	
Χ	Ferrite Wire-wound (Drum type)

#### (4) Features, Characteristics

Code	
В	Standard

#### ②Features

Code	Feature
Н	Bottom electrode (Frame type)

#### ③寸法(L×W)

Code	Dimensions $(L \times W)$ [mm]
100	10.0 × 9.8

#### ④寸法(H)

Code	Dimensions (H) [mm]
50	5.0

#### **⑤**Operating temperature

Туре

10050

Code	Operating temperature [°C]
Н	<b>−25∼+105</b>

#### **6**Packaging

Code	Packaging
L	Taping

#### (7)Nominal inductance

Tronina inductance		
Code (example)	Nominal inductance[μH]	
1R3	1.3	
100	10	
101	100	

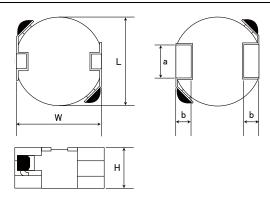
★R=Decimal point

#### 8 Inductance tolerance

Code Inductance tolerance	
М	±20%
N	±30%

9Internal code

#### ■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



L

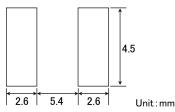
 $10.0 \pm 0.3$ 

 $(0.394 \pm 0.012)$ 

#### Recommended Land Patterns

#### Surface Mounting

- ·Mounting and soldering conditions should be checked beforehand.
- •Applicable soldering process to these products is reflow soldering only.



н	а	b	Standard quantity [pcs] Taping
5.0 max (0.197 max)	4.0 (0.16)	1.75 (0.07)	500

Unit:mm(inch)

W

 $9.8 \pm 0.5$ 

 $(0.386 \pm 0.020)$ 

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#### PART NUMBER

#### ●10050 type

Todoo type	Old nast sumbas		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Managemen
New part number	Old part number (for reference)	EHS	[ $\mu$ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[kHz]
LSXBH10050HL1R3N	NR 10050T 1R3N	RoHS	1.3	±30%	53	0.0068	11,000	9,000	100
LSXBH10050HL2R1N	NR 10050T 2R1N	RoHS	2.1	±30%	37	0.0080	10,000	8,300	100
LSXBH10050HL2R9N	NR 10050T 2R9N	RoHS	2.9	±30%	29	0.0093	8,200	7,300	100
LSXBH10050HL3R8N	NR 10050T 3R8N	RoHS	3.8	±30%	26	0.013	7,300	6,800	100
LSXBH10050HL4R9N	NR 10050T 4R9N	RoHS	4.9	±30%	23	0.015	6,600	6,000	100
LSXBH10050HL6R5N	NR 10050T 6R5N	RoHS	6.5	±30%	19	0.018	6,000	5,200	100
LSXBH10050HL100M	NR 10050T 100M	RoHS	10	±20%	15	0.025	4,700	4,100	100
LSXBH10050HL150M	NR 10050T 150M	RoHS	15	±20%	11	0.035	3,600	3,200	100
LSXBH10050HL220M	NR 10050T 220M	RoHS	22	±20%	10	0.045	2,600	2,500	100
LSXBH10050HL330M	NR 10050T 330M	RoHS	33	±20%	8.2	0.066	2,500	2,100	100
LSXBH10050HL470M	NR 10050T 470M	RoHS	47	±20%	7.0	0.092	2,000	1,800	100
LSXBH10050HL680M	NR 10050T 680M	RoHS	68	±20%	5.6	0.144	1,700	1,500	100
LSXBH10050HL101M	NR 10050T 101M	RoHS	100	±20%	4.6	0.209	1,300	1,200	100
LSXBH10050HL221M	NR 10050T 221M	RoHS	220	±20%	3.0	0.450	1,000	800	100

imes) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

XX)The maximum rated current is the DC current value that satisfies both of current value Saturation current value and temperature rise current value. (at 20°C)

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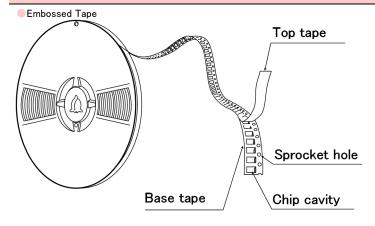
#### Wire-wound Ferrite Power Inductors LSXBH10050/LLXBH10050

#### PACKAGING

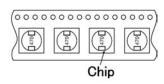
#### 1 Minimum Quantity

Tuna	Standard Quantity [pcs]
Туре	Tape & Reel
10050	500

#### **2**Tape Material

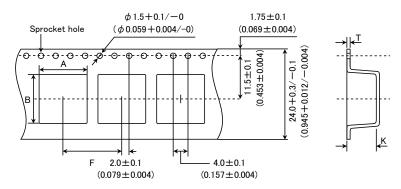


#### Chip Filled



#### 3 Taping dimensions

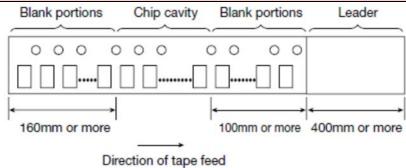
#### ●Embossed tape 24mm wide (0.945 inches wide)



Turna	Chip o	cavity	Insertion pich	Tape thickness	
Туре	Α	В	F	Т	K
10050	10.4±0.1	9.9±0.1	16.0±0.1	0.5±0.05	5.7±0.1
10000	$(0.409 \pm 0.004)$	$(0.390 \pm 0.004)$	$(0.630 \pm 0.004)$	$(0.020\pm0.002)$	$(0.224 \pm 0.004)$

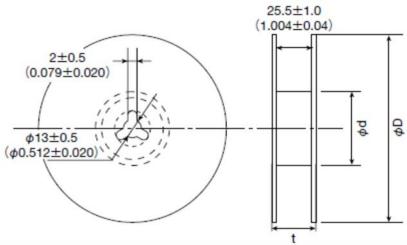
Unit:mm(inch)

#### 4 Leader and Blank portion



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#### ⑤Reel size

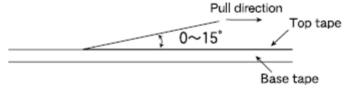


Typo	Reel size (Reference valus			
Type	$\phi$ D	$\phi$ d	t(max.)	
10050	330±3	80±2	30.5	
10050	$(12.99 \pm 0.118)$	$(3.15 \pm 0.078)$	(1.201)	

Unit:mm(inch)

#### **6**Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



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# Wire-wound Ferrite Power Inductors LSXBH10050 for General Electronic Equipment for Consumer Wire-wound Ferrite Power Inductors LLXBH10050

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

# POPLIADULITY DATA

RELIABILITY DA	ATA				
1. Operating Temp					
Specified Value	−25~+105°C				
Test Methods and Remarks	Including self-generated heat				
2. Storage Temper	ature Range				
Specified Value	-40~+85°C				
Test Methods and Remarks	-5 to 40°C for the product with taping.				
3. Rated current					
Specified Value	Within the specified tolerance				
4. Inductance					
Specified Value	Within the specified tolerance				
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4263A or equivalent)  Measuring frequency : 100kHz, 1V				
5. DC Resistance					
Specified Value	Within the specified tolerance				
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)				
6. Self resonance f	frequency				
Specified Value	Within the specified tolerance				
Test Methods and Remarks	Measuring equipment : Impedance analyzer/material analyzer(HP4291A or equivalent HP4191A, 4192A or equivalent)				
7. Temperature ch	aracteristic				
Specified Value	Inductance change : Within ±20%				
Test Methods and Remarks	Measurement of inductance shall be taken at temperature range within $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$ . With reference to inductance value at $+20^{\circ}\text{C}$ , change rate shall be calculated. Change of maximum inductance deviation in step 1 to 5  Step  Temperature (°C)  1  20				
	2 Minimum operating temperature 3 20 (Standard temperature) 4 Maximum operating temperature				
	5 20				
8. Resistance to fle	evire of substrate				
Specified Value	1 -				

#### 9. Insulation resistance : between wires

Specified Value

#### 10. Insulation resistance : between wire and core

Specified Value -

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11. Withstanding vo	Itage : between wire and core				
Specified Value	_				
12. Adhesion of terr	ninal electrode				
Specified Value	Shall not come off PC board				
Test Methods and	Applied force : 5N to X and Y directions.				
Remarks	Duration : 5s.				
40 D					
13. Resistance to v					
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.				
	The test samples shall be soldered to the test board by the reflow.				
	Then it shall be submitted to below test conditions.				
	Frequency Range 10~55Hz				
Test Methods	Total Amplitude 1.5mm (May not exceed acceleration 196m/s²)				
and Remarks	Sweeping Method 10Hz to 55Hz to 10Hz for 1min.				
	Time Y For 2 hours on each X, Y, and Z axis.				
	Z Z				
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.				
14. Solderability					
Specified Value	At least 90% of surface of terminal electrode is covered by new solder.				
Opcomed value	The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.				
	Flux: Ethanol solution containing rosin 25%.				
Test Methods and Remarks	Solder Temperature 245±5°C				
Remarks	Time 5±1.0 sec.				
	*Immersion depth : All sides of mounting terminal shall be immersed.				
15. Resistance to s	oldering heat				
C:E1 \/-l	Inductance change : Within ±10%				
Specified Value	No significant abnormality in appearance.				
	The test sample shall be exposed to reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times.				
Test Methods and Remarks	Test board material : Glass epoxy-resin Test board thickness : 1.6mm				
and itemarks	Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.				
-					
16. Thermal shock					
Specified Value	Inductance change : Within ±10%				
- Opcomed Value	No significant abnormality in appearance.				
	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified				
	time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.  Conditions of 1 cycle				
Test Methods	Step Temperature (°C) Duration (min)				
	1 —40±3 30±3				
and Remarks	2 Room temperature Within 3				
	3 +85±2 30±3				
	4 Room temperature Within 3				
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.				

17. Damp heat
Specified Value

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18. Loading under	damp heat
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.
19. Low temperatu	re life test
Specified Value	Inductance change : Within ±10%  No significant abnormality in appearance.
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.
	·
20. High temperatu	ıre life test
Specified Value	_
Test Methods and Remarks	
21. Loading at high	temperature life test
Specified Value	1-
<u> </u>	
22. Standard cond	tion
Specified Value	Standard test condition: Unless otherwise specified, temperature is $20\pm15^{\circ}$ C and $65\pm20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20\pm2^{\circ}$ C of temperature, $65\pm5\%$ relative humidity. Inductance is in accordance with our measured value.

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Wire-wound Ferrite Power Inductors LSXN/LSXP series

for General Electronic Equipment for Consumer

Wire-wound Ferrite Power Inductors LSXBH10050 for General Electronic Equipment for Consumer

Wire-wound Ferrite Power Inductors LSRN series for General Electronic Equipment for Consumer

Wire-wound Ferrite Power Inductors LLXN/LLXP series

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

Wire-wound Ferrite Power Inductors LLXBH10050

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

Wire-wound Ferrite Power Inductors LLRN series

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

#### **PRECAUTIONS**

#### 1. Circuit Design

Precautions

- ◆Verification of operating environment, electrical rating and performance
  - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications. As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.
  - 2. When inductors are used in places where dew condensation develops and/or where corrosive gas such as hydrogen sulfide, sulfurous acid, or chlorine exists in the air, characteristic deterioration may occur. Please do not use inductors under such environmental conditions
- ◆Operating Current (Verification of Rated current)
  - 1. The operating current including inrush current for inductors must always be lower than their rated values.
  - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.
  - ◆Temperature rise

Temperature rise of power choke coil depends on the installation condition in end products.

Make sure that temperature rise of power choke coils in actual end products is within the specified temperature range.

#### 2. PCB Design

#### Precautions

#### ◆Land pattern design

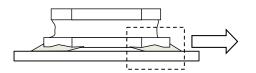
- 1. Please refer to a recommended land pattern.
- 2. There is stress, which has been caused by distortion of a PCB, to the inductor. (LSXN/LSXP/LLXN/LLXP)
- 3. Please consider the arrangement of parts on a PCB. (LSXN/LSXP/LLXN/LLXP)

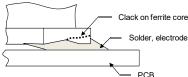
#### ◆Land pattern design

Surface Mounting

- 1. Mounting and soldering conditions should be checked beforehand.
- 2. Applicable soldering process to this products is reflow soldering only.
- 3. Please use the recommended land pattern shown as below. Electrical characteristics and the mounting ability of the product are being considered in the recommended land pattern. If a PCB is designed with other dimensions, defective soldering and stress to a product may occur due to misalignment. The performance of the product may not be brought out. If an adopted land pattern is different from the recommended land pattern, stress to the product will increase. It may cause cracks or defective electrical characteristics of the product. Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (LSXN/LSXP/LLXN/LLXP)
- 4. As coefficients of thermal expansion between an inductor and a PCB differs, cracks may occur on a ferrite core when thermal stress is applied to them after mounting an inductor. (Please refer to the drawings below.) Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (LSXN/LSXP/LLXN/LLXP)

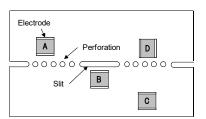
### Technical considerations





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 SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board. (LSXN/LSXP/LLXN/LLXP)



A product tends to undergo stress in order "A>C>B = D".

Please consider the layouts of a product to minimize any stresses.

# 3. Considerations for automatic placement Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. 2. Stress may be applied to a product with a warp or a twist in handling of the product. Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (LSXN/LSXP/LLXN/LLXP) Technical considerations ≺Twist>

#### 4. Soldering

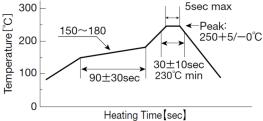
- ◆Reflow soldering
  - 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.
  - 2. The product shall be used reflow soldering only.
- 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.
- ◆Lead free soldering
- Precautions
- When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.
- ◆Recommended conditions for using a soldering iron(Repair)
  - Put the soldering iron on the land-pattern.
  - Soldering iron's temperature Below 350°C
  - Duration 3 seconds or less
  - · The soldering iron should not directly touch the inductor.

#### ◆Reflow soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

Recommended reflow condition (Pb free solder)

# Technical considerations



# 5. Cleaning Precautions Cleaning conditions 1. Washing by supersonic waves shall be avoided. Technical considerations 1. If washed by supersonic waves, the products might be broken.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/)

6. Handling	
Precautions	<ul> <li>♦ Handling</li> <li>1. Keep the product away from all magnets and magnetic objects.</li> <li>♦ Breakaway PC boards (splitting along perforations)</li> <li>1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board.</li> <li>2. Board separation should not be done manually, but by using the appropriate devices.</li> <li>♦ Mechanical considerations</li> <li>1. Please do not give the product any excessive mechanical shocks.</li> <li>2. Please do not add any shock and power to a product in transportation.</li> <li>♦ Pick-up pressure</li> <li>1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part.</li> <li>♦ Packing</li> <li>1. Please avoid accumulation of a packing box as much as possible.</li> </ul>
Technical considerations	<ul> <li>✦Handling</li> <li>1. There is a case that a characteristic varies with magnetic influence.</li> <li>✦Breakaway PC boards (splitting along perforations)</li> <li>1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs.</li> <li>✦Mechanical considerations</li> <li>1. There is a case to be damaged by a mechanical shock.</li> <li>2. There is a case to be broken by the handling in transportation.</li> <li>✦Pick-up pressure</li> <li>1. Damage and a characteristic can vary with an excessive shock or stress.</li> <li>✦Packing</li> <li>1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.</li> </ul>

7. Storage condi	tions
Precautions	<ul> <li>♦ Storage         <ol> <li>To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.</li> <li>Storage conditions</li></ol></li></ul>
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

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